

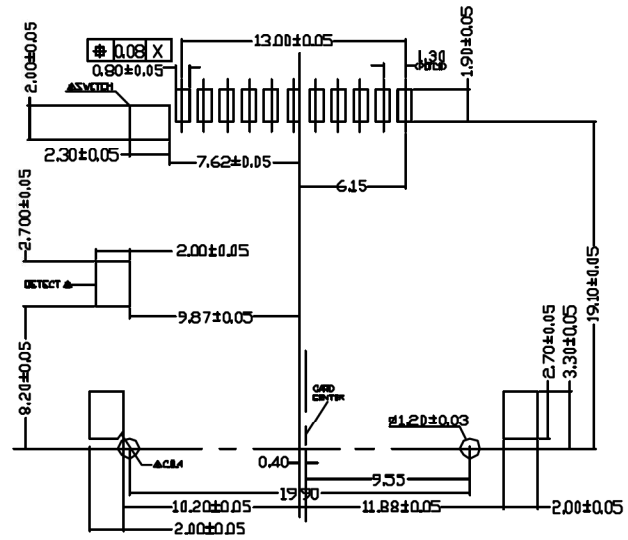
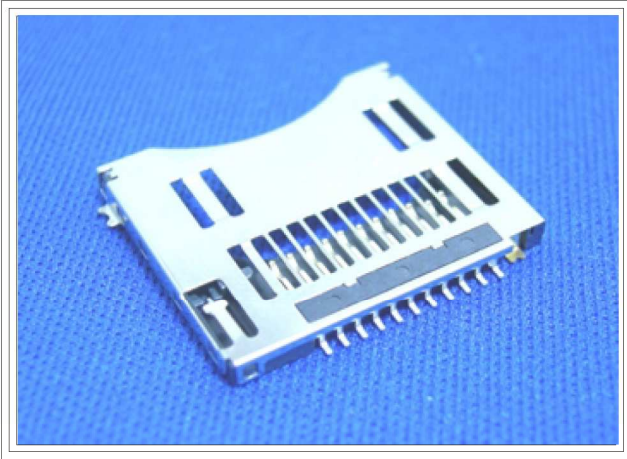
Mini SD Card Connector

Reverse Push-Pull Type

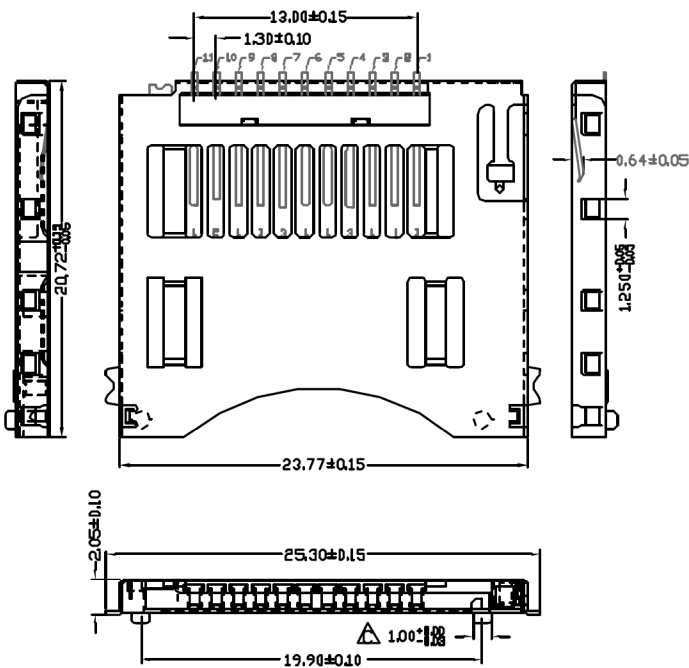
ISO14001 QC080000 ISO14001 QC080000 ISO14001 QC080000 ISO14001 QC080000 ISO14001

Part No:

MDDMF-11108BT00



P.C.B layout



1. DAT1	MIDDLE	7. NC	MIDDLE
2. DAT0	MIDDLE	8. VSS	LONG
3. VSS	MIDDLE	9. CMD	MIDDLE
4. CLK	MIDDLE	10. CD/DAT3	SHORT
5. VDD	LONG	11. DAT2	MIDDLE
6. NC	MIDDLE		

Specification:

MATERIAL

HOUSING:HIGH TEMPERATURE THERMOPLASTIC

CONTACT:COPER ALLOY

SHELL:COPPER ALLOY

PLATING

CONTACT AREA:GOLD PLATED OVER NI

SOLDER TAIL:100u" MIN Sn/Pb PLATED OVER NI

SHELL SOLDER AREA:GOLD PLATED OVER NI

PATING

CURRENT RATING:0.5A

VOLTAGE RATING:250VRMS

OPERATING

TEMPERATURE:-25C~+90C

SPECIFICATION

CONTACT RESISTANCE:40 MILLIOHMS

DIELECTRIC WITHSTANDING VOLTAGE:500VAC MEGOHMS

INSULATION RESISTANCE:100 MEGOHMS

Application:

MINI SD CARD USE